

### Design Notes

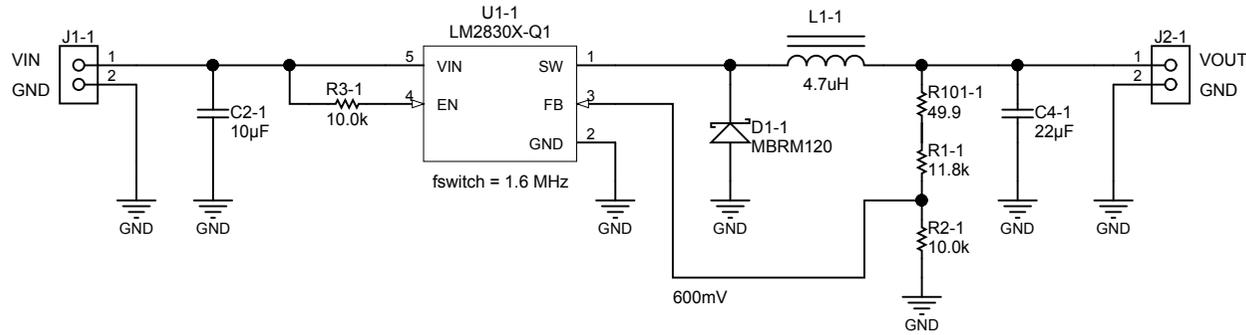
- \* Built on "LM2830/31 SOT23-5 EVAL"
- \* R101-X for test purpose only
- \* Passive components tuned for same performance

### Revision History

Revision	Notes
A	* Built & tested

#### Input

4.5 .. 5.5V

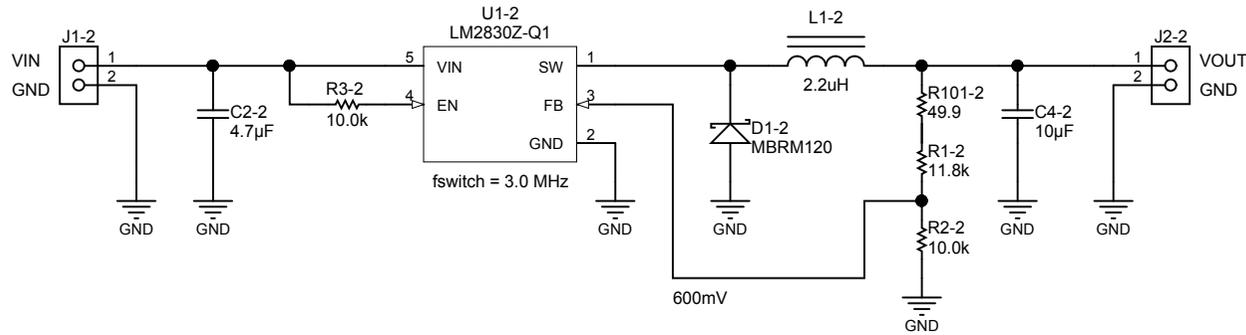


#### Output

1.3V @ 0.6A

#### Input

4.5 .. 5.5V



#### Output

1.3V @ 0.6A

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Number: PMP8631 Rev: A  
 SVN Rev: Not in version control  
 Drawn By:  
 Engineer: Matthias Ulmann

Designed for: Public Release Mod. Date: 6/13/2013  
 Project Title: 4.5 .. 5.5V -> 1.3V @ 0.6A  
 Sheet Title:  
 Assembly Variant: Variant name not interpreted Sheet: 1 of 1  
 File: PMP8631RevA.SchDoc Size: A4  
 Contact: <http://www.ti.com/support>



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